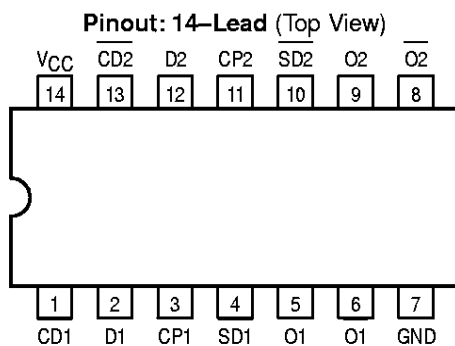


Low-Voltage Quiet CMOS Dual D-Type Flip-Flop

The MC74LVQ74 is a high performance, dual D-type flip-flop with asynchronous clear and set inputs and complementary (O, O) outputs. It operates from a 2.7 to 3.6V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance.

The MC74LVQ74 consists of 2 edge-triggered flip-flops with individual D-type inputs. The flip-flop will store the state of individual D inputs, that meet the setup and hold time requirements, on the LOW-to-HIGH Clock (CP) transition.

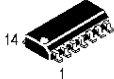
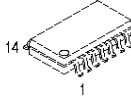


- Designed for 2.7 to 3.6V V_{CC} Operation – Ideal for Low Power/Low Noise Applications
- Guaranteed Simultaneous Switching Noise Level and Dynamic Threshold Performance
- Guaranteed Skew Specifications
- Guaranteed Incident Wave Switching into 75Ω
- Low Static Supply Current (10μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500mA
- ESD Performance: Human Body Model >2000V



MC74LVQ74

LVQ

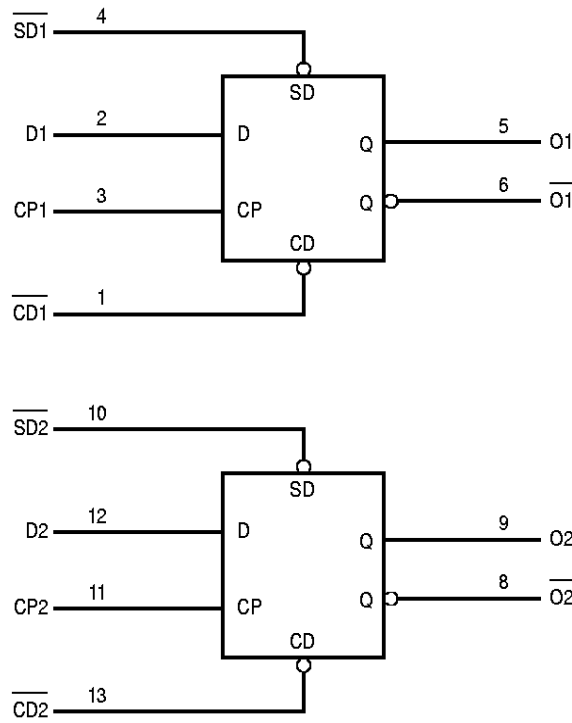
**LOW-VOLTAGE CMOS
DUAL D-TYPE FLIP-FLOP**

	D SUFFIX PLASTIC SOIC CASE 751A-03
	M SUFFIX PLASTIC SOIC EIAJ CASE 965-01
	SD SUFFIX PLASTIC SSOP CASE 940A-03
	DT SUFFIX PLASTIC TSSOP CASE 948G-01

PIN NAMES

Pins	Function
CP1, CP2	Clock Pulse Inputs
D1, D2	Data Inputs
CD1, CD2	Direct Clear Inputs
SD1, SD2	Direct Set Inputs
O _n , O _n	Outputs

LOGIC DIAGRAM



INPUTS				OUTPUTS		OPERATING MODE
SDn	CDn	CPn	Dn	On	On	
L	H	X	X	H	L	Asynchronous Set
H	L	X	X	L	H	Asynchronous Clear
L	L	X	X	H	H	Undetermined
H	H	↑	h	H	L	Load and Read Register
H	H	↑	l	L	H	
H	H	↕	X	NC	NC	Hold

H = High Voltage Level; h = High Voltage Level One Setup Time Prior to the Low-to-High Clock Transition; L = Low Voltage Level; l = Low Voltage Level One Setup Time Prior to the Low-to-High Clock Transition; NC = No Change; X = High or Low Voltage Level or Transitions are Acceptable; ↑ = Low-to-High Transition; ↕ = Not a Low-to-High Transition; For I_{CC} Reasons DO NOT FLOAT Inputs

ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Value	Condition	Unit
V _{CC}	DC Supply Voltage	-0.5 to +7.0		V
V _I	DC Input Voltage	-0.5 ≤ V _I ≤ V _{CC} + 0.5V		V
V _O	DC Output Voltage	-0.5 ≤ V _O ≤ V _{CC} + 0.5	Output in HIGH or LOW State	V
I _{IK}	DC Input Diode Current	-20	V _I = -0.5V	mA
		+20	V _I = V _{CC} + 0.5V	mA
I _{OK}	DC Output Diode Current	-20	V _O = -0.5V	mA
		+20	V _I = V _{CC} + 0.5V	mA
I _O	DC Output Source/Sink Current	±50		mA
I _{CC}	DC Supply Current	±200		mA
I _{GND}	DC Ground Current	±200		mA
T _{STG}	Storage Temperature Range	-65 to +150		°C

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	2.0	3.3	3.6	V
V _I	Input Voltage	0		V _{CC}	V
V _O	Output Voltage	0		V _{CC}	V
T _A	Operating Free-Air Temperature	-40		+85	°C
ΔV/Δt	Input Transition Rise or Fall Rate, V _{I(N)} from 0.8V to 2.0V, V _{CC} = 3.0V	0		125	mV/ns

DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	T _A = -40°C to +85°C		Unit
			Min	Max	
V _{IH}	HIGH Level Input Voltage (Note 1)	2.7V ≤ V _{CC} ≤ 3.6V, V _O = 0.1V or V _{CC} - 0.1V	2.0		V
V _{IL}	LOW Level Input Voltage (Note 1)	2.7V ≤ V _{CC} ≤ 3.6V, V _O = 0.1V or V _{CC} - 0.1V		0.8	V
V _{OH}	HIGH Level Output Voltage	2.7V ≤ V _{CC} ≤ 3.6V; I _{OH} = -50μA	V _{CC} - 0.1		V
		V _{CC} = 2.7V; I _{OH} = -12mA	2.2		
		V _{CC} = 3.0V; I _{OH} = -12mA	2.48		
V _{OL}	LOW Level Output Voltage	2.7V ≤ V _{CC} ≤ 3.6V; I _{OL} = 50μA		0.1	V
		2.7V ≤ V _{CC} ≤ 3.6V; I _{OL} = 12mA		0.4	
I _I	Input Leakage Current	2.7V ≤ V _{CC} ≤ 3.6V; V _I = V _{CC} , GND		±1.0	μA
I _{OLD}	Minimum Dynamic Output Current (Note 2)	V _{CC} = 3.6V; V _{OLD} = 0.8V Max		36	mA
I _{OHD}		V _{CC} = 3.6V; V _{OHD} = 2.0V Min		-25	mA
I _{CC}	Quiescent Supply Current	2.7V ≤ V _{CC} ≤ 3.6V; V _I = V _{CC} , GND		10	μA

1. These values of V_I are used to test DC electrical characteristics only. Functional test should use V_{IH} ≥ 2.4V, V_{IL} ≤ 0.5V.
2. Incident wave switching on transmission lines with impedances as low as 75Ω for commercial temperature range is guaranteed. Maximum test duration is 2ms, one output loaded at a time.

DYNAMIC SWITCHING CHARACTERISTICS ($V_{CC} = 3.3V$)

Symbol	Characteristic	Condition	$T_A = +25^\circ C$			Unit
			Min	Typ	Max	
V_{OLP}	Dynamic LOW Peak Voltage (Note 1)	$C_L = 50pF, V_{IH} = 3.3V, V_{IL} = 0V$		0.6	1.0	V
V_{OLV}	Dynamic LOW Valley Voltage (Note 1)	$C_L = 50pF, V_{IH} = 3.3V, V_{IL} = 0V$		-0.5	-1.0	V
V_{IHD}	High Level Dynamic Input Voltage (Note 2)	Input-Under-Test Switching 0V to Threshold, $f=1MHz$		1.5	2.0	V
V_{ILD}	Low Level Dynamic Input Voltage (Note 2)	Input-Under-Test Switching 3.3V to Threshold, $f=1MHz$		1.5	0.8	V

1. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW. The remaining output is measured in the LOW state.
2. Number of data inputs is defined as "n" switching, "n-1" inputs switching 0V to 3.3V.

AC CHARACTERISTICS ($t_R = t_F = 2.5ns; C_L = 50pF; R_L = 500\Omega$)

Symbol	Parameter	Limits									Unit
		$T_A = +25^\circ C$						$T_A = -40^\circ C \text{ to } +85^\circ C$			
		$V_{CC} = 3.0V \text{ to } 3.6V$			$V_{CC} = 2.7V$			$V_{CC} = 3.0V \text{ to } 3.6V$		$V_{CC} = 2.7V$	
		Min	Typ	Max	Min	Typ	Max	Min	Max	Max	
f_{max}	Maximum Clock Frequency	100	125		55	100		95			MHz
t_{PLH} t_{PHL}	Propagation Delay CPn to On or On	4.5 3.5	8.0 6.5	13.5 12.5	4.5 3.5	9.5 7.5	17.5 15.0	4.0 3.5	16.0 14.5	20.0 18.0	ns
t_{PLH} t_{PHL}	Propagation Delay SDn or CDn to On or On	3.5 4.0	6.5 7.0	12.0 12.0	4.0 4.0	7.5 8.0	14.5 15.5	3.5 3.5	13.0 13.5	18.0 18.0	ns
t_{OSHL} t_{OSLH}	Output-to-Output Skew (Note 1)		1.0 1.0	1.5 1.5		1.0 1.0	1.5 1.5		1.5 1.5	1.5 1.5	ns

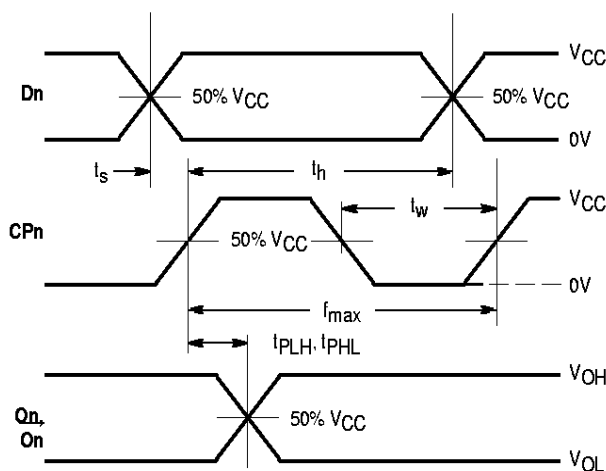
1. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

AC OPERATING REQUIREMENTS ($t_R = t_F = 2.5ns; C_L = 50pF; R_L = 500\Omega$)

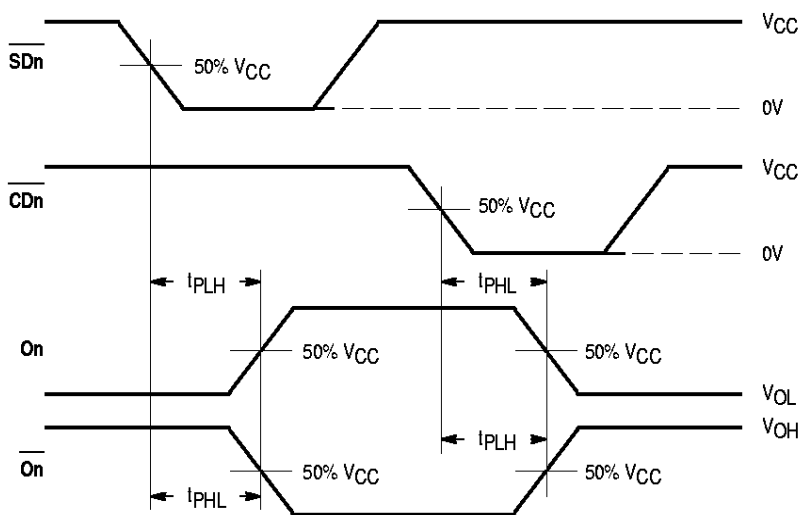
Symbol	Parameter	Limits				Unit
		$T_A = +25^\circ C$		$T_A = -40^\circ C \text{ to } +85^\circ C$		
		$V_{CC} = 3.0V \text{ to } 3.6V$		$V_{CC} = 2.7V$		
		Min	Min	Min	Min	
t_s	Setup Time, HIGH or LOW Dn to CPn	4.0	5.0	4.5	6.5	ns
t_h	Hold Time, HIGH or LOW Dn to CPn	0.5	0.5	0.5	0.5	ns
t_w	SDn or CDn Pulse Width, LOW	5.5	7.0	7.0	10.0	ns
t_w	CPn Pulse Width HIGH or LOW	5.5	7.0	7.0	10.0	ns
t_{rec}	Recovery Time SDn or CDn to CPn	0.0	0.0	0.0	0.0	ns

CAPACITIVE CHARACTERISTICS

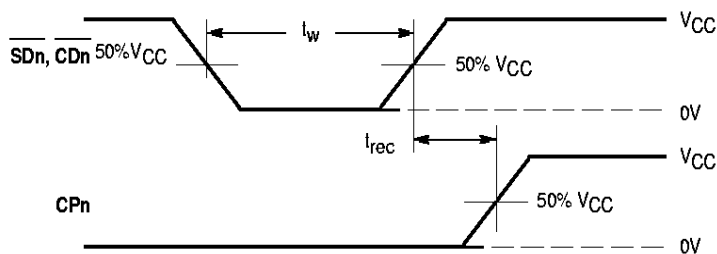
Symbol	Parameter	Condition	Typical	Unit
C_{PD}	Power Dissipation Capacitance	10MHz, $V_{CC} = 3.3V, V_I = 0V \text{ or } V_{CC}$	25	pF
C_{IN}	Input Capacitance	$V_{CC} = \text{Open}, V_I = 0V \text{ or } V_{CC}$	4.5	pF



WAVEFORM 1 – PROPAGATION DELAYS, SETUP AND HOLD TIMES
 $t_R = t_F = 2.5ns$, 10% to 90%; $f = 1MHz$; $t_W = 500ns$

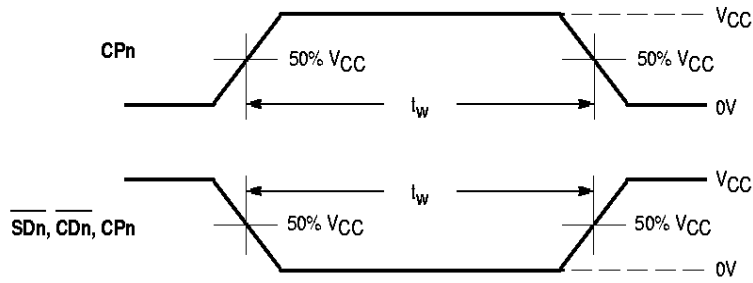


WAVEFORM 2 – PROPAGATION DELAYS
 $t_R = t_F = 2.5ns$, 10% to 90%; $f = 1MHz$; $t_W = 500ns$



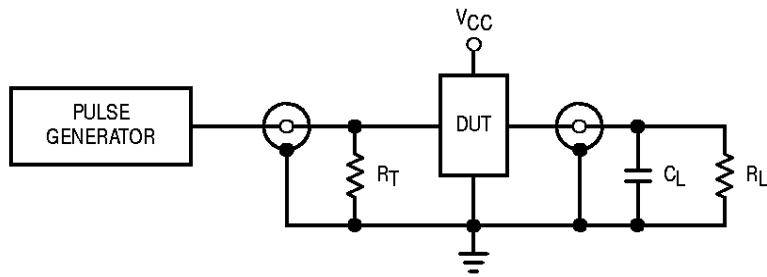
WAVEFORM 3 – RECOVERY TIME
 $t_R = t_F = 2.5ns$ from 10% to 90%; $f = 1MHz$; $t_W = 500ns$

Figure 1. AC Waveforms



WAVEFORM 4 – PULSE WIDTH
 $t_R = t_F = 2.5ns$ (or fast as required) from 10% to 90%;
 Output requirements: $V_{OL} \leq 0.8V, V_{OH} \geq 2.0V$

Figure 1. AC Waveforms (continued)

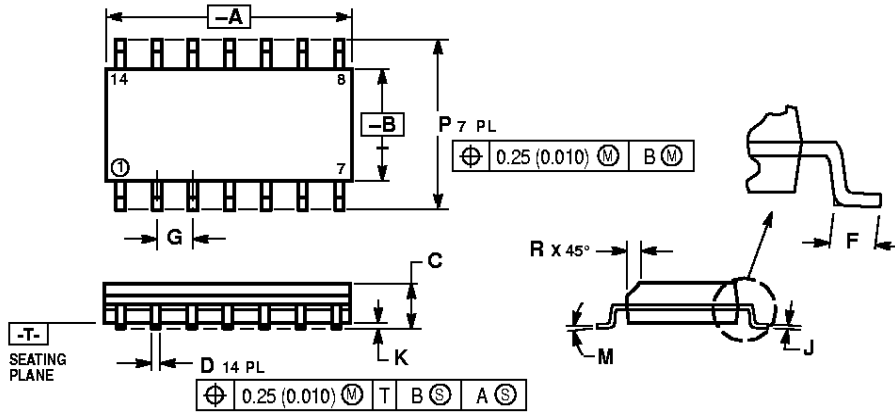


$C_L = 50pF$ or equivalent (Includes jig and probe capacitance)
 $R_L = R_1 = 500\Omega$ or equivalent
 $R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 2. Test Circuit

OUTLINE DIMENSIONS

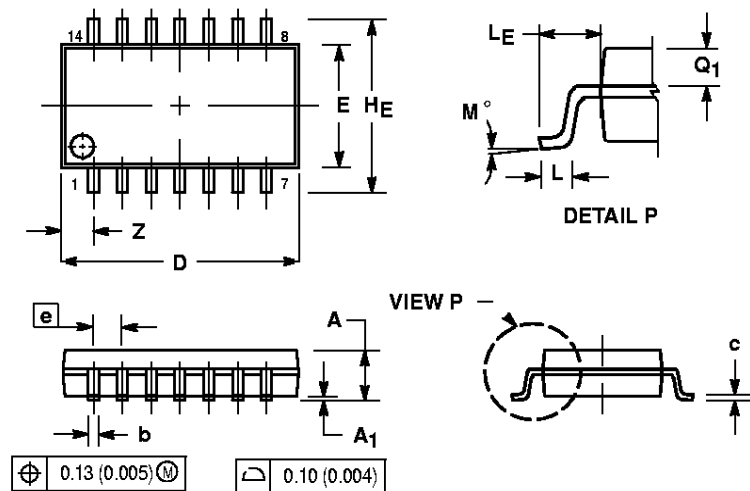
D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751A-03
ISSUE F



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

M SUFFIX
PLASTIC SOIC EIAJ PACKAGE
CASE 965-01
ISSUE O

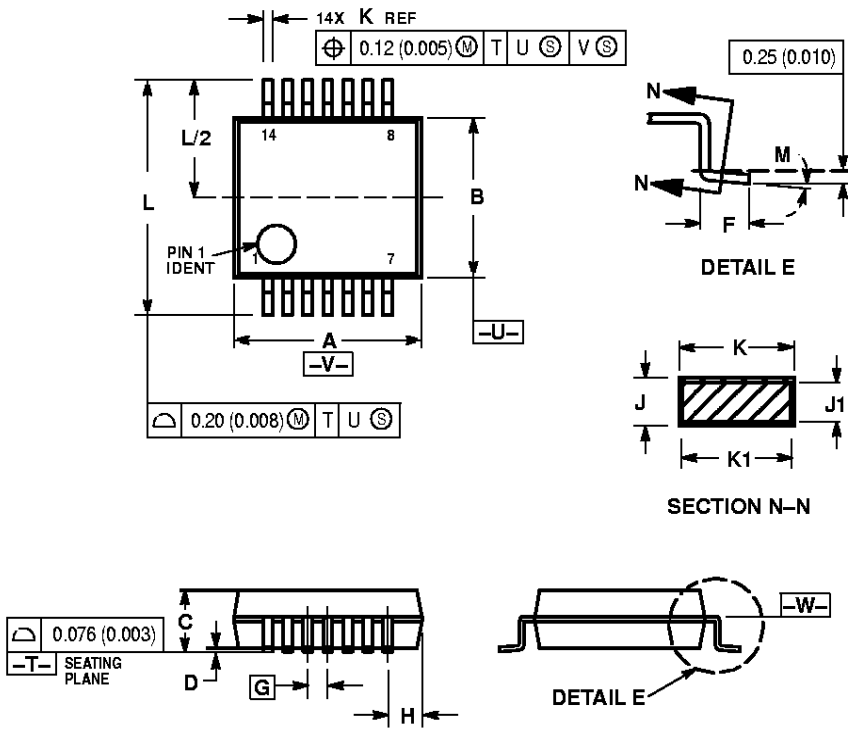


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 5. THE LEAD WIDTH DIMENSION (c) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A1	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.80	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q1	0.70	0.90	0.028	0.035
Z	---	1.42	---	0.056

OUTLINE DIMENSIONS

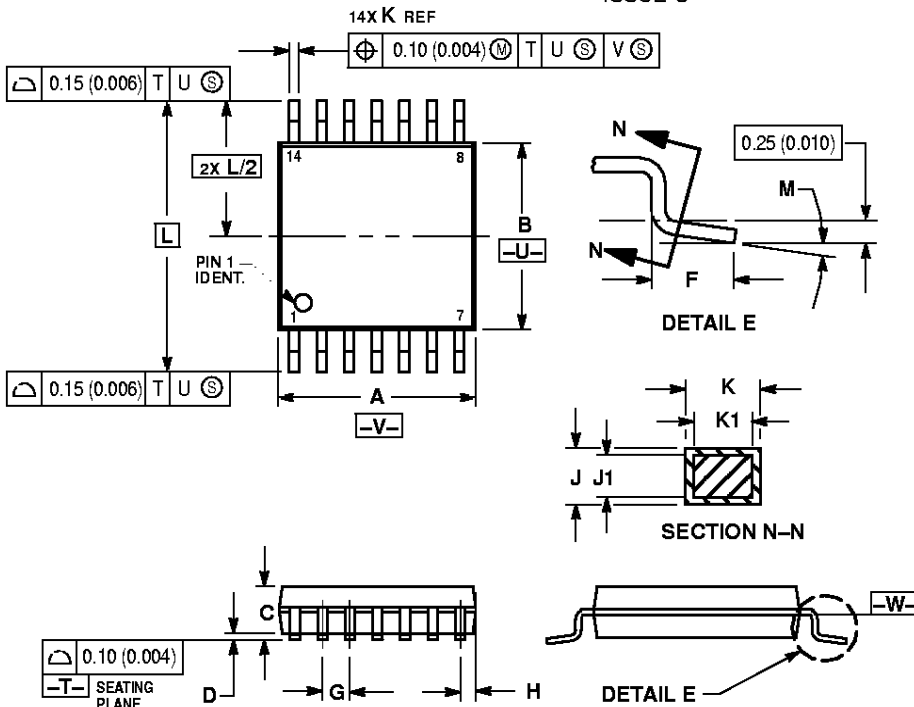
SD SUFFIX
PLASTIC SSOP PACKAGE
CASE 940A-03
ISSUE B



- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - CONTROLLING DIMENSION: MILLIMETER.
 - DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 - DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 - DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
 - TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 - DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.07	6.33	0.238	0.249
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
H	1.08	1.22	0.042	0.048
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°

DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948G-01
ISSUE O



- NOTES:
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - CONTROLLING DIMENSION: MILLIMETER.
 - DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 - DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 - DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 - TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 - DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

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